

TOSHIBA Photocoupler GaAs IRED & Photo-Transistor

# TLP627, TLP627-2, TLP627-4

Programmable Controllers  
DC-output Module  
Telecommunication

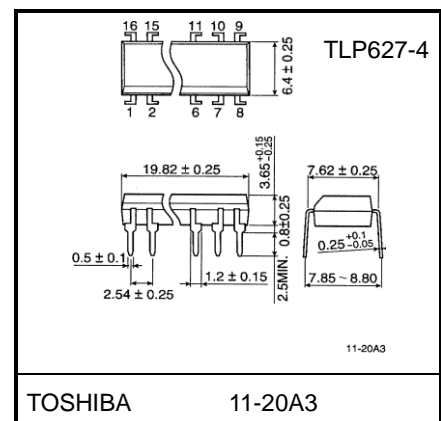
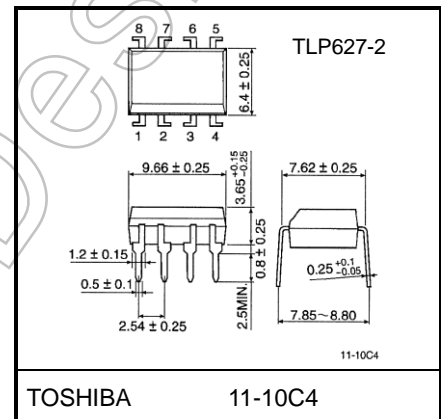
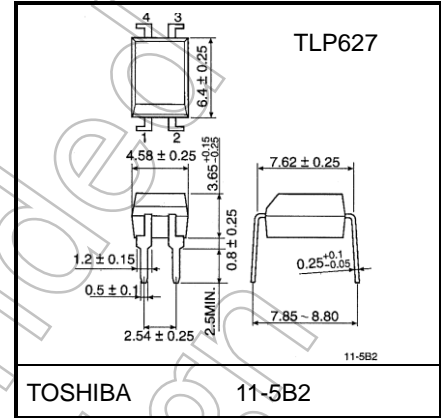
The TOSHIBA TLP627,-2 and -4 consist of a gallium arsenide infrared emitting diode optically coupled to a Darlington connected phototransistor which has an integral base-emitter resistor to optimize switching speed and elevated temperature characteristics.

The TLP627-2 offers two isolated channels in eight lead plastic DIP, while the TLP627-4 provide four isolated channels per package.

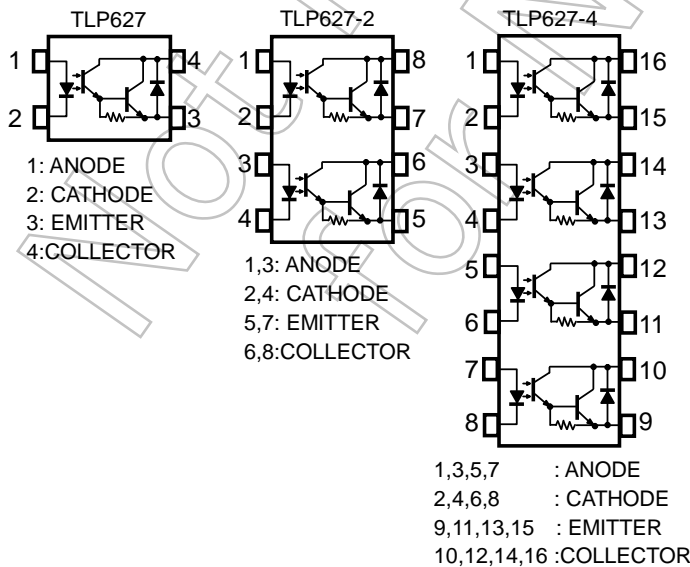
- Collector-Emitter Voltage : 300 V (min)
- Current Transfer Ratio : 1000 % (min)
- UL recognized : UL1577, File No. E67349
- cUL recognized : CSA Component Acceptance Service No. 5A  
File No.E67349
- SEMKO approved :9808210/01-03  
EN60065,EN60950  
(approved TLP627 and TLP627-2)
- Option (D4) type  
VDE approved : EN60747-5-5  
Maximum operating insulation voltage: 890Vpk  
Highest permissible over voltage: 8000Vpk

**Note:** When an EN 60747-5-5 approved type is needed, please designate the "Option(D4)".

Unit: mm



**Pin Configuration (top view)**



Start of commercial production  
1984-08

## Absolute Maximum Ratings (Ta=25°C)

Characteristics		Symbol	Rating		Unit
			TLP627	TLP627-2 TLP627-4	
LED	Forward Current	I <sub>F</sub>	60	50	mA
	Forward Current Derating	ΔI <sub>F</sub> /°C	-0.7(Ta≥39°C)	-0.5(Ta≥25°C)	mA /°C
	Pulse Forward Current	I <sub>FP</sub>	1 (100μs pulse, 100pps)		A
	Reverse Voltage	V <sub>R</sub>	5		V
	Diode Power Dissipation (1 Circuit)	P <sub>D</sub>	100	70	mW
	Diode Power Dissipation Derating (1 Circuit)	ΔP <sub>D</sub> /°C	-1.2 (Ta≥39°C)	-0.7 (Ta≥25°C)	mW /°C
Detector	Collector-Emitter Voltage	V <sub>CEO</sub>	300		V
	Emitter -Collector Voltage	V <sub>ECO</sub>	0.3		V
	Collector Current	I <sub>C</sub>	150		mA
	Collector Power Dissipation (1 Circuit)	P <sub>C</sub>	150(300(Note 1))	100	mW
	Collector Power Dissipation Derating (Ta≥25°C, 1 Circuit)	ΔP <sub>C</sub> /°C	-1.5(-3.5(Note 1))	-1.0	mW /°C
Operating Temperature Range		T <sub>opr</sub>	-55 to 100		°C
Storage Temperature Range		T <sub>stg</sub>	-55 to 125		°C
Lead Soldering Temperature		T <sub>sol</sub>	260(10s)		°C
Total Package Power Dissipation (1 Circuit)		P <sub>T</sub>	250(320(Note 1))	150	mW
Total Package Power Dissipation Derating (Ta≥25°C, 1 Circuit)		ΔP <sub>T</sub> /°C	-2.5(-3.2(Note 1))	-1.5	mW /°C
Isolation Voltage (AC, 60 s, R.H. ≤ 60%) (Note 2)		BV <sub>s</sub>	5000		V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: I<sub>F</sub>=20mA Max

Note 2: Device considered a two-terminal device : LED side pins Shorted together and DETECTOR side pins shorted together.

## Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply Voltage	V <sub>CC</sub>	—	—	200	V
Forward Current	I <sub>F</sub>	—	16	25	mA
Collector Current	I <sub>C</sub>	—	—	120	mA
Operating Temperature	T <sub>opr</sub>	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

## Electrical Characteristics (Ta=25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward Voltage	$V_F$	$I_F = 10 \text{ mA}$	1.0	1.15	1.3	V
	Reverse Current	$I_R$	$V_R = 5 \text{ V}$	—	—	10	$\mu\text{A}$
	Capacitance	$C_T$	$V = 0 \text{ V}, f = 1\text{MHz}$	—	30	—	pF
Detector	Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C = 0.1\text{mA}$	300	—	—	V
	Emitter-Collector Breakdown Voltage	$V_{(BR)ECO}$	$I_E = 0.1\text{mA}$	0.3	—	—	V
	Collector Dark Current	$I_{CEO}$	$V_{CE} = 200\text{V}$	—	10	200	nA
			$V_{CE} = 200\text{V}, T_a = 85^\circ\text{C}$	—	—	20	$\mu\text{A}$
Capacitance Collector to Emitter	$C_{CE}$	$V = 0 \text{ V}, f = 1\text{MHz}$	—	10	—	pF	

## Coupled Electrical Characteristics (Ta=25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Current Transfer Ratio	$I_C/I_F$	$I_F = 1\text{mA}, V_{CE} = 1\text{V}$	1000	4000	—	%
Saturated CTR	$I_C/I_F(\text{sat})$	$I_F = 10\text{mA}, V_{CE} = 1\text{V}$	500	—	—	%
Collector-Emitter Saturation Voltage	$V_{CE(\text{sat})}$	$I_C = 10\text{mA}, I_F = 1\text{mA}$	—	—	1.0	V
		$I_C = 100\text{mA}, I_F = 10\text{mA}$	0.3	—	1.2	

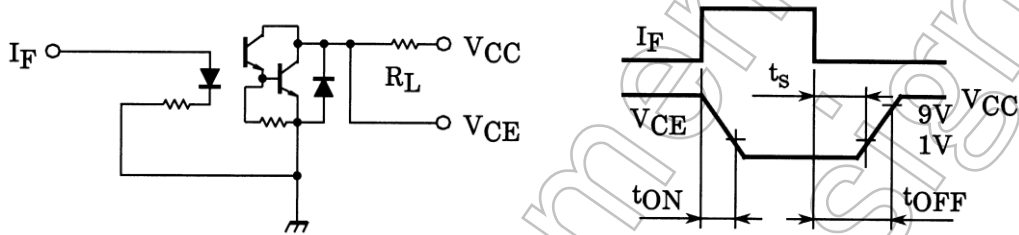
## Isolation Electrical Characteristics (Ta=25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance Input to Output	$C_S$	$V_S = 0 \text{ V}, f = 1\text{MHz}$	—	0.8	—	pF
Isolation Resistance	$R_S$	$V_S = 500\text{V}, R.H. \leq 60\%$	$5 \times 10^{10}$	$10^{14}$	—	$\Omega$
Isolation Voltage	BVs	AC, 60 s	5000	—	—	V <sub>rms</sub>
		AC, 1s, in oil	—	10000	—	
		DC, 60 s, in oil	—	10000	—	V <sub>dc</sub>

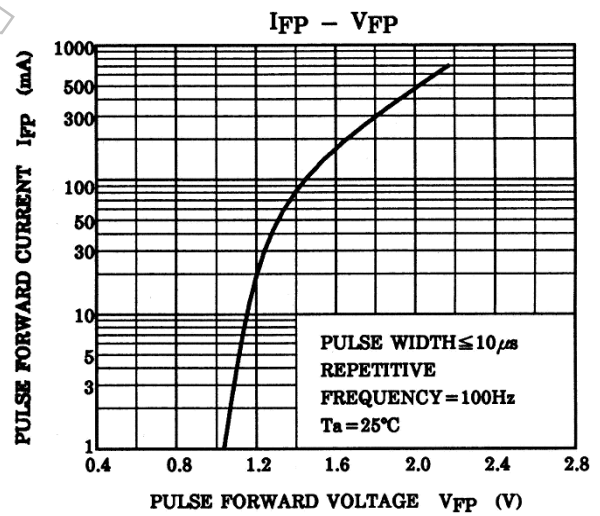
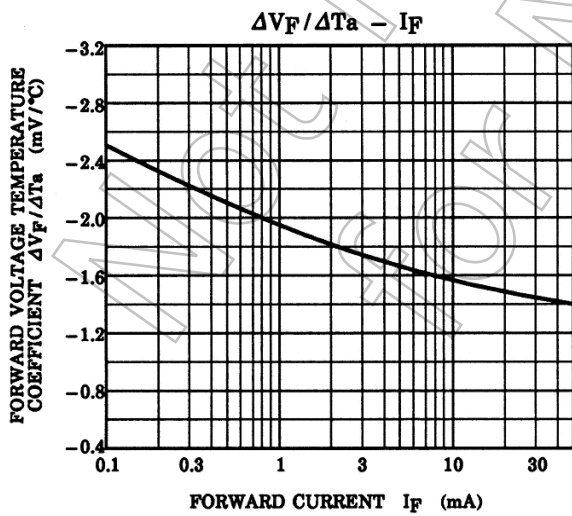
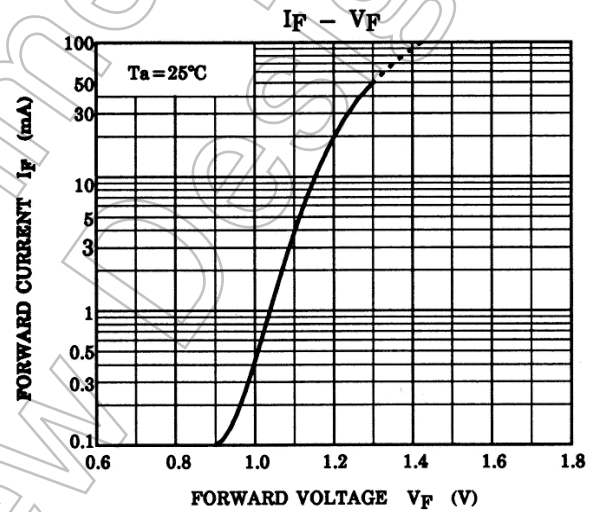
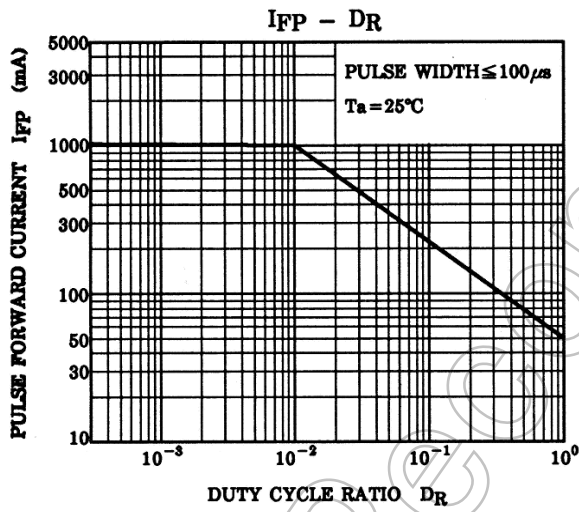
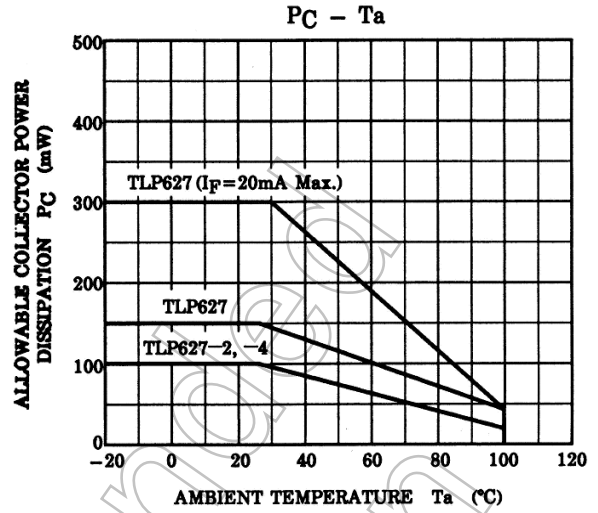
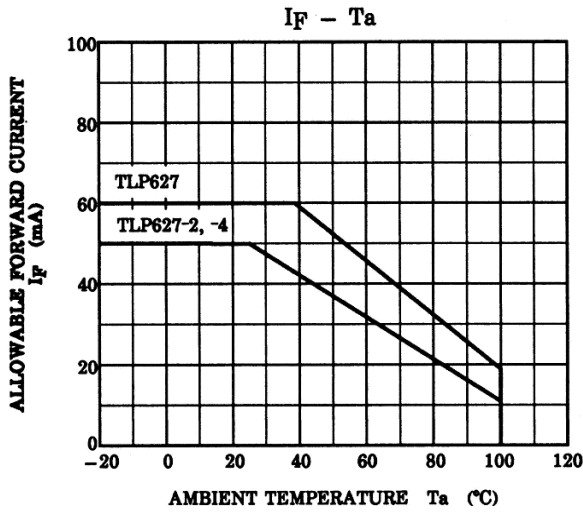
**Switching Characteristics (Ta=25°C)**

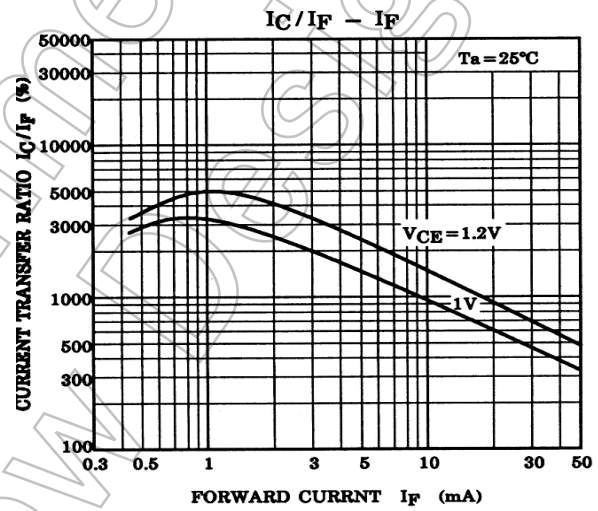
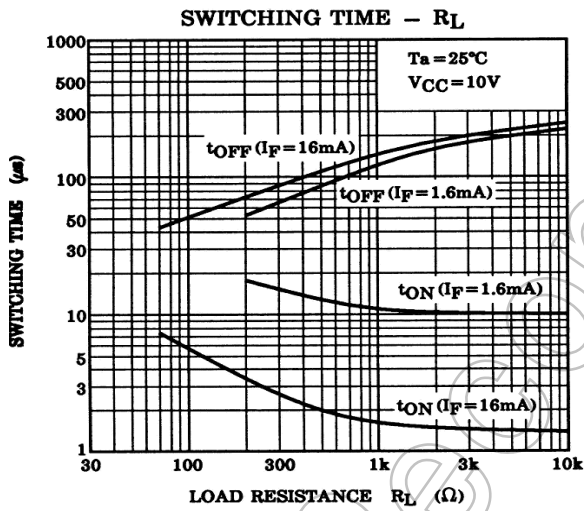
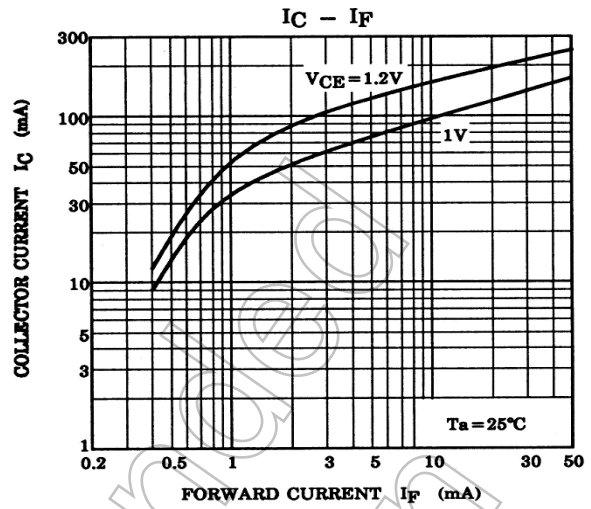
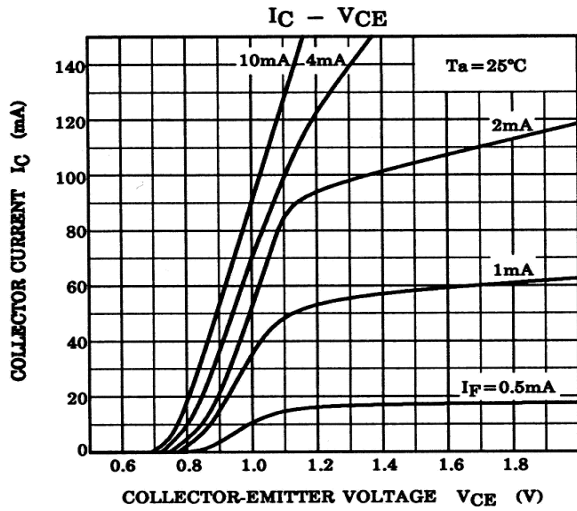
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Rise Time	$t_r$	VCC=10V Ic=10mA RL=100Ω	—	40	—	μs
Fall Time	$t_f$		—	15	—	
Turn-on Time	$t_{on}$		—	50	—	
Turn-off Time	$t_{off}$		—	15	—	
Turn-on Time	$t_{ON}$	RL=180Ω (Fig.1) VCC=10V, IF=16mA	—	5	—	
Storage Time	$t_s$		—	40	—	
Turn-off Time	$t_{OFF}$		—	80	—	

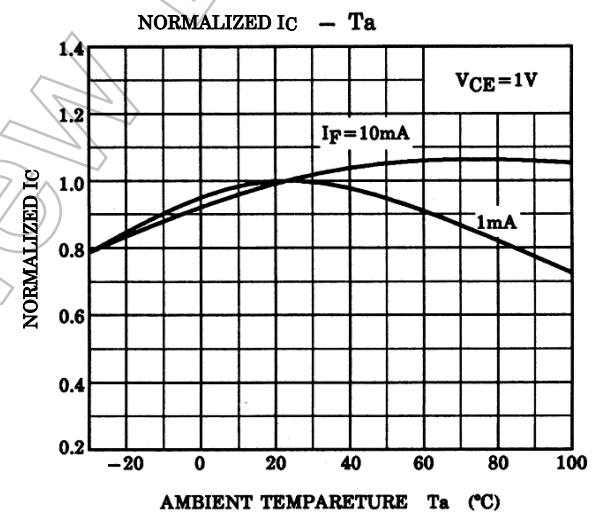
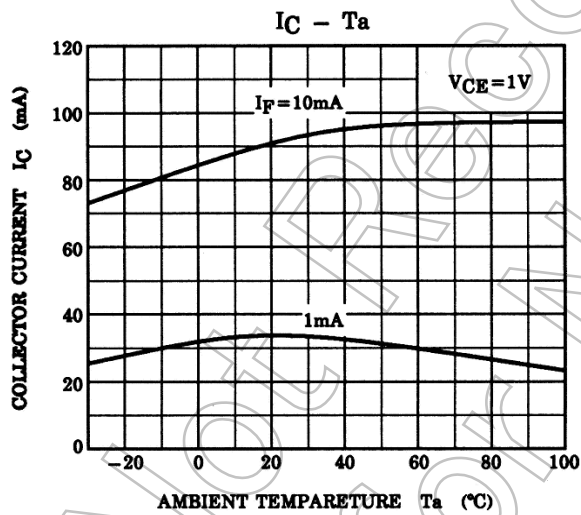
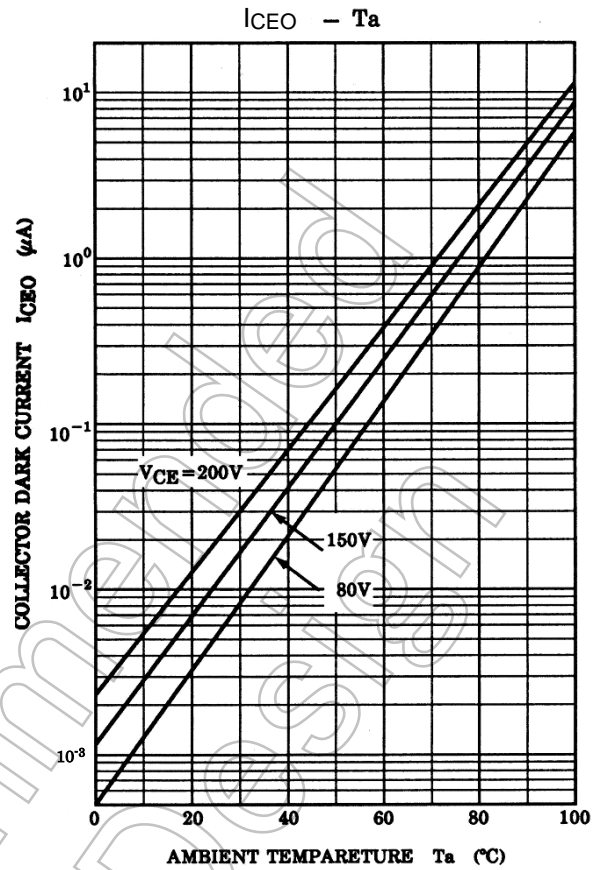
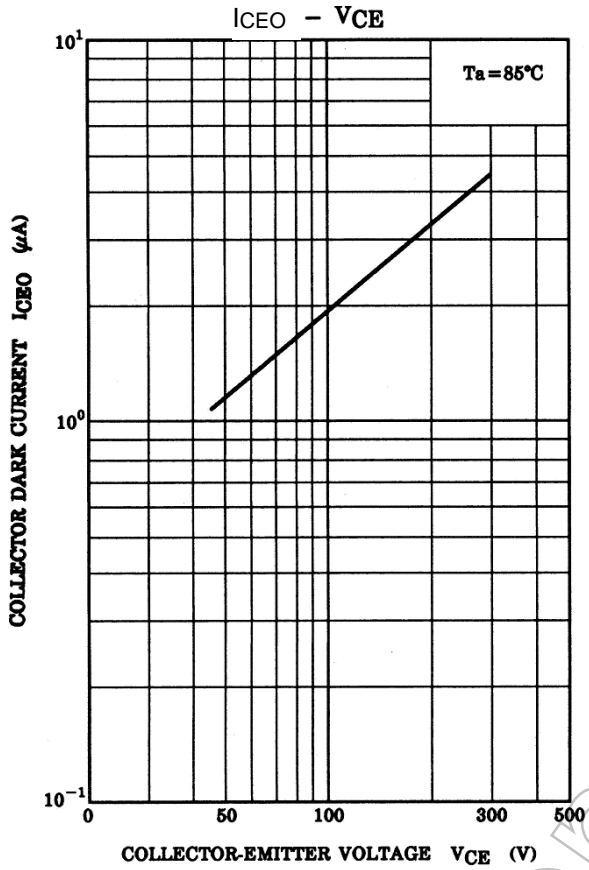
**Fig.1 Switching Time Test Circuit**



Not Recommended for New Design







## RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. **TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.**
- **PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE").** Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. **IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT.** For details, please contact your TOSHIBA sales representative.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- **ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.**
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. **TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.**